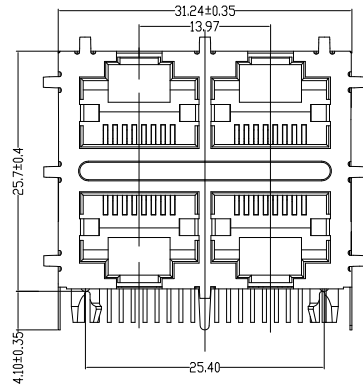
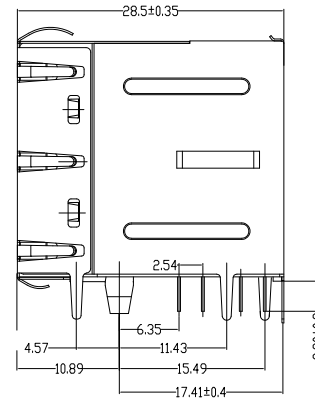


Mechanical:

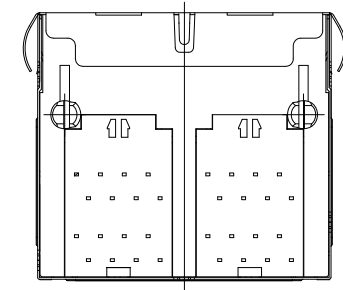
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2015-02-02	



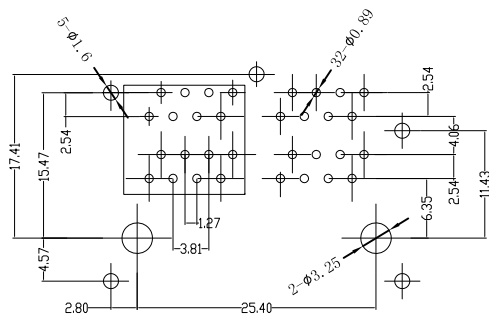
Front Side View



Left Side View



Bottom Side View



Suggested PCB Layout



NOTES:

1. Meets IEEE 802.3 specification
2. Connector Materials:
 Housing Material: Thermoplastic PA66+30%G.F UL94V-0
 Contact Material: Phosphor Bronze C5210R-EH Thickness=0.35mm
 Pins: Brass C2680R-H Thickness=0.35mm
 Shield: Copper alloy Brass H65Y Thickness=0.20mm
 Shield plating: Nickel
 Contact plating: Gold 6 micro-inches min. In contact area.
3. Wave solder tip temperature: 265°C Max, 5 Sec Max

X:X ±0.25	APPD:	LINK-PP INT'L TECHNOLOGY Co., LIMITED		
X:XX ±0.20	CHKD:	TITLE: 2*2 RJ45 Connector with 10/100 Base-T Integrated Magnetics		
X:XXX ±0.05	DR: FRANK	PART NO.: LPJ27202CNL		
ANGLES ±1°	UNIT: mm			
	SCALE: 2/1	SHEET: 2/2	REV: A	DWG NO.: LPC15020207